# **TDH** Series

## 35 Watt D2PAK Package Thick Film Power Surface Mount



Ohmite's TDH resistor is an economical solution to intermediate power application design requirements. TDH's reliable thick film on alumina substrate construction can be easily heat sinked for higher power performance. TDH resistors are ideal for pulse-loading, pre-charge, bleeder, and snubber applications.



CHARACTERISTICS

## FEATURES

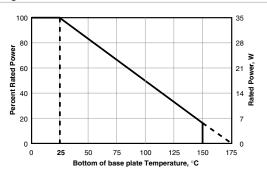
- 35 Watt power rating at 25°C
- SMD D2PAK package configuration
- Heat resistance to cooling plate: Rth <4.28°C/W
- A molded case for environmental protection.
- Resistor element is electrically insulated from the metal sink tab.

Terminal	Copper	
Terminal Plating	Terminals- SnAg, Thermal Header- German Silver/Nickel Silver	
Resistance Range	$0.05\Omega$ to $10K\Omega$ other values on request	
Tolerance	±1% to ±10% (0.5% on request)	
Max. Operating Voltage	350V	
Insulation Resistance	10GΩ min.	
Power Rating	Depends upon case temperature. See der- ating curve. D2PAK style power package for surface mounting applications; 35W power rating at 25°C case temperature.	
Working Temperature Range	-55°C to +175°C	
Solder Process	The TDH35P cannot exceed 215°C (260°C for the TDH35H)	
Derating	100% @ 25°C to 0% @ 150°C curve refer- enced to case temperature	
Dielectric Strength	1,800VAC	
Operating Temperature Range	-55°C to +150°C	
Temperature Coefficient	Referenced to $25^{\circ}$ C, $\Delta$ R taken at $+105^{\circ}$ C 10 $\Omega$ and above: $\pm 50$ ppm°C For under 10 $\Omega$ : 3R to 9R9: 100ppm 1R to 2R9: 300ppm 0R1 to 0R99: 700ppm 0R05 to 0R09: 1000ppm	
Inductance	less than 20 nanohenries	
Flatness	less than 0.1mm tolerance	

**Soldering note:** During surface mount soldering the soldering temperature profile must not cause the metal tab of this device to exceed 215°C (260°C for the TDH35H)!

Test	Condition	Result
Load Life	MIL-R-39009, 2,000 hours	ΔR ±(1.0% +0.01Ω)
Moisture Resistance	MIL-Std-202, Method 106	ΔR =(0.5% +0.01Ω) max.
Short Time Overload	2 times rated power with applied voltage not to exceed 1.5 times maximum continu- ous operating voltage for 5 seconds	ΔR ±(0.3% +0.01Ω) max.
Thermal Shock	MIL–Std–202, Method 107, Cond. F	ΔR =(0.3% +0.01Ω) max.
Terminal Strength	MIL–Std–202, Method 211, Cond. A (Pull Test) 2.4N	ΔR =(0.2% +0.01Ω) max.
Vibration, High Frequency	MIL-Std-202, Method 204, Cond. D	ΔR =(0.2% +0.01Ω) max.

#### Derating



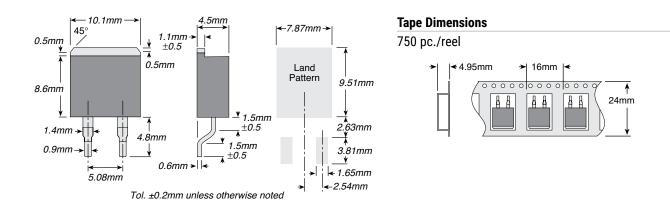
Derating (thermal resistance): 0.23W/°C (4.28°C/W). The case temperature is to be used for purposes of establishing the applied power limit. The case temperature measurement must be made with a thermocouple contacting the center of the component mounted on the designed heat sink. Thermal grease should be applied propperly.

### (continued)

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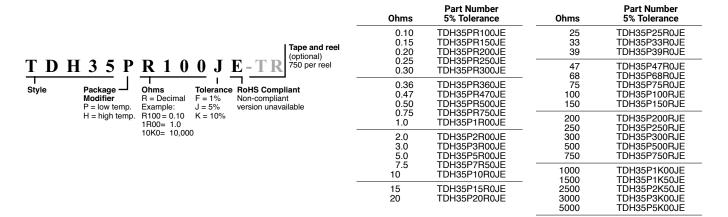
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## DIMENSIONS



#### ORDERING INFORMATION

## Standard Part Numbers



## THIS PRODUCT IS DESIGNED FOR USE WITH PROPER HEATSINKING.

Maximum base plate temperature of the resistor must be monitored and kept within specified limits to establish the power rating. Best technique is to attach a thermocouple to the side of the base plate of the resistor. Temperature of plastic housing or heat sink cannot be used to establish rating of the resistor.

